

## Special Issue

# Applications of Artificial Intelligence on Social Media

### Message from the Guest Editors

With the explosive increase of social media across the world, such as TikTok, WeChat, Twitter, and Facebook, people have the opportunity to connect with others, and to record their social activities. Advancements in artificial intelligence (especially deep learning) technology have provided a powerful force to enhance the user experience and satisfaction on social media. This Special Issue welcomes papers on a full range of research in the application of artificial intelligence in social media.

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### Guest Editors

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### Deadline for manuscript submissions

closed (10 July 2023)



## Applied Sciences

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### Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal Applied Sciences has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

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### Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo  
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